

The background features a vibrant blue gradient. On the left, the Nokia logo is displayed in white. To the right, a large white circle frames a complex, multi-colored wavy structure. This structure is composed of numerous thin, overlapping lines that create a sense of depth and movement, with colors ranging from deep red to bright blue. The overall aesthetic is modern and scientific.

NOKIA

Science Day PhD thesis presentation

Krzysztof Gajewski

21.01.2025

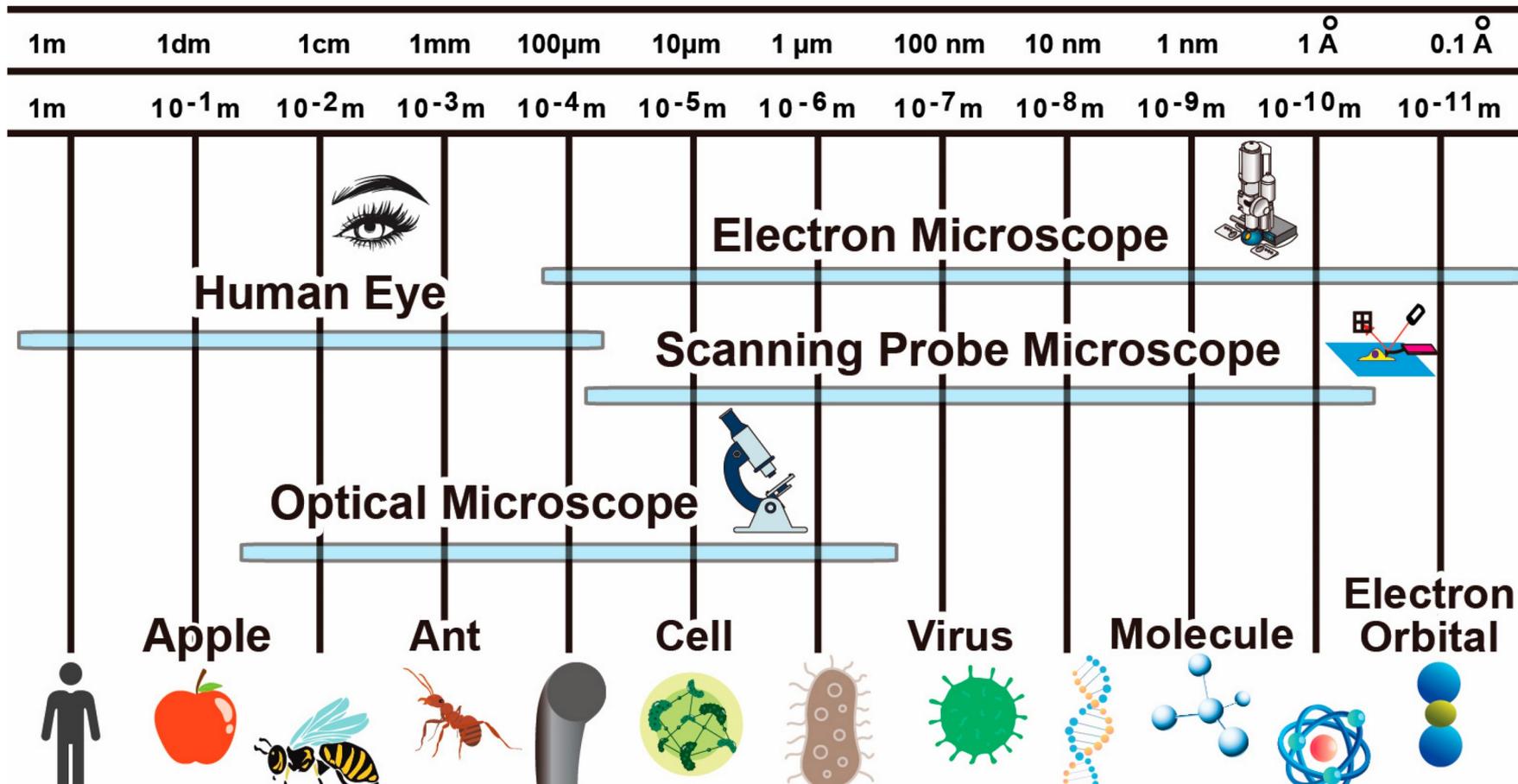
Agenda

1. Who am I?
2. What did I do?
3. Summary

Who am I?

- MN, **Network Management**
- Nokian since 05.2020 as a SW developer
- Since 11.2022 as a SW architect
- Involved in 3 projects

Relative Sizes and Microscopy Tools





Wrocław
University
of Science
and Technology

PL: Grafenowe przetworniki nanoelektromechaniczne

EN: Graphene nanoelectromechanical systems



Supervisor prof. dr hab. inż. Teodor Gotszalk



INNOWACYJNA
GOSPODARKA
NARODOWA STRATEGIA SPÓJNOŚCI



Fundacja na rzecz Nauki Polskiej



Politechnika Wrocławska

UNIA EUROPEJSKA
EUROPEJSKI FUNDUSZ
ROZWOJU REGIONALNEGO



This work was supported by the Foundation for Polish Science TEAM Programme “High-resolution force and mass metrology using MEMS/NEMS devices – FoMaMet” (Grant No. TEAM/2012-9/3), co-financed by the European Regional Development Fund resources within the framework of Operational Program Innovative Economy



NARODOWE CENTRUM NAUKI

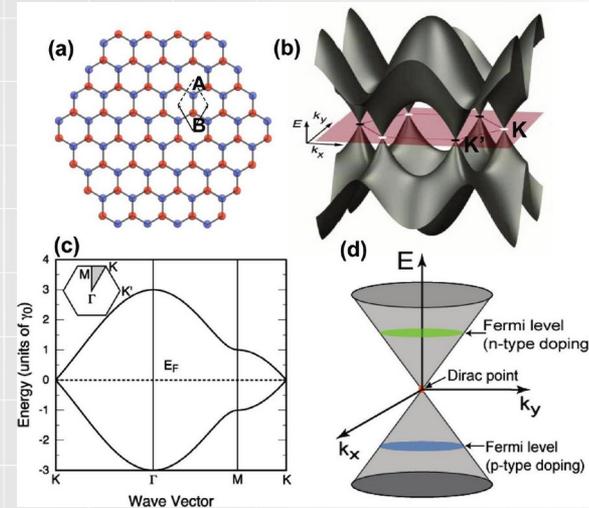
This work was supported by the National Science Centre, Poland by the PRELUDIUM 9 programme "Investigations of the properties of graphene nanoelectromechanical systems with the use of scanning probe microscopy and Raman spectroscopy" (grant Nr 2015/17/N/ST7/03850)



Some of presented works were supported by the FP7 project STREP NanoHeat (Nr 318625) „Multidomain platform for integrated More-than-Moore/Beyond CMOS systems characterisation & diagnostics.” financed using the European funds.

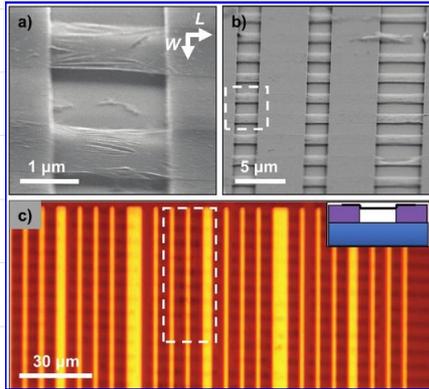
Graphene

- Carbon atoms connected by in-plane strength sp^2 bonds
- Free π electrons
- Lattice constants $a_{AB} = 1.41 \text{ \AA}$, $a_{AA} = 2.45 \text{ \AA}$
- Electron velocity $v_F \sim 10^6 \text{ ms}^{-1}$
- Electron mobility $\sim 200\,000 \text{ cm}^2\text{V}^{-1}\text{s}^{-1}$
- Graphene ambipolarity - in dependence of external electric field it can be „n” or „p” type
- Thermal conductivity 3080 - 5150 W/mK

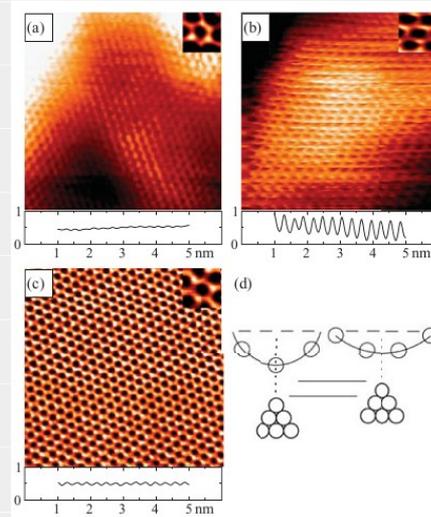


P. Avouris, Nano Lett. 2010,10;
4285-94.

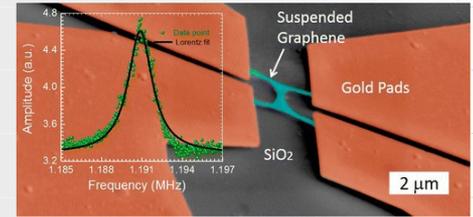
Graphene and GNEMs



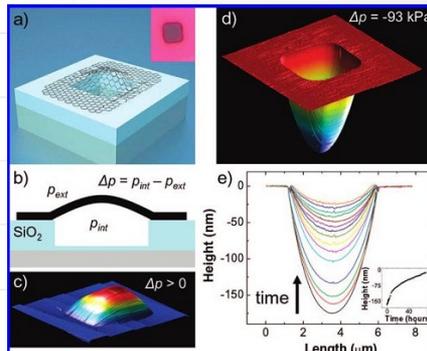
Zande AMVD, et al., *Nano letters* 2010, 10 (12), 4869-73.



Xu P, et al., *PRB* 2012, 85(12): 121406(R).

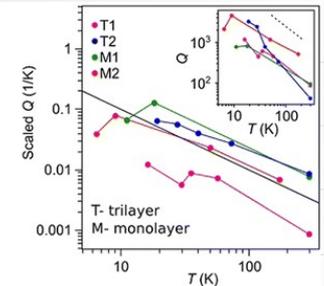
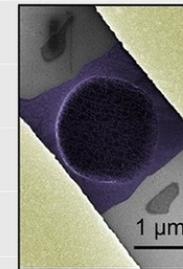


M. Kumar, et al., *Nano Lett.*, 2015, 15 (4), 2562-2567



Bunch JS, et al., *Nano Lett.* 2008, 8 (8):2458-62.

T. Miao, et. al, *Nano Lett.*, 2014, 14 (6), 2982-2987





The main goal of the thesis

- Development of methods and techniques for graphene nanoelectromechanical systems investigation using microscopic and spectroscopic technologies
- The main focus was put on scanning probe microscopy and Raman spectroscopy

The main goal could be achieved by:

Project and GNEMS preparation

Scanning tunneling microscope
preparation which will be able to
measure GNEMS

Atomic force microscopy
techniques adaptation for GNEMS

GNEMS investigations

The main goal could be achieved by:

Project and GNEMS preparation

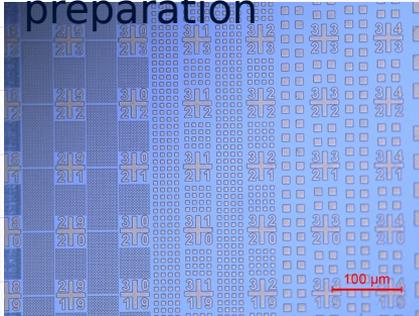
Scanning tunneling microscope
preparation which will be able to
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Atomic force microscopy
techniques adaptation for GNEMS

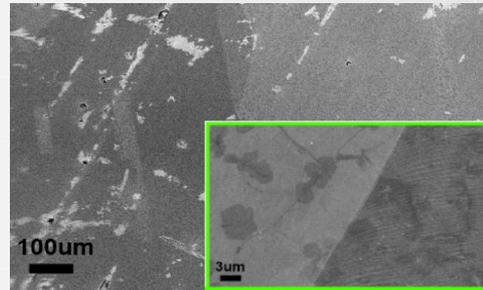
GNEMS investigations

Typical GNEMS sample processing

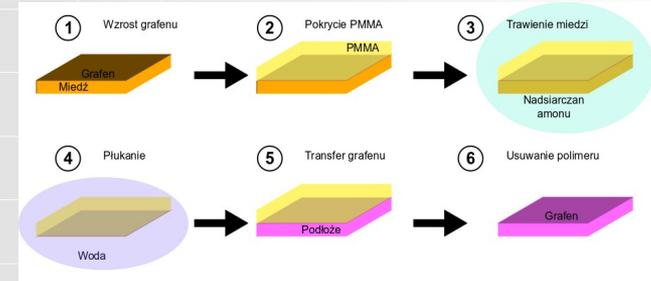
Substrate preparation



Graphene growth



Graphene transfer



Gajewski, K. R., et al., Proc. SPIE 8902, Electron Technology Conference 2013, 89020G (July 25, 2013).

- 300 nm SiO₂ / Si.
- Apply photoresist
- Photolithography
- Photoresist removal
- SiO₂ etching

Goniszewski, S.,..., **K. Gajewski**, et al., IET Circuits, Devices & Systems, 2015, 9, (6), p. 420-427.

- Growth on copper foil
- Low pressure (110 mbar), high temperature (1035 °C).
- Methane as a carbon source
- Hydrogen used to minimize oxidation
- Graphene covered by PMMA
- Graphene etching from the bottom side using nitric acid.
- Copper etching using ammonium persulfate.
- Graphene cleaning.
- Transfer.
- PMMA etching in dichloromethane
- Annealing (350 °C ,10 h, P≈ 2 mbar, hydrogen flow 100 sccm)

The main goal could be achieved by:

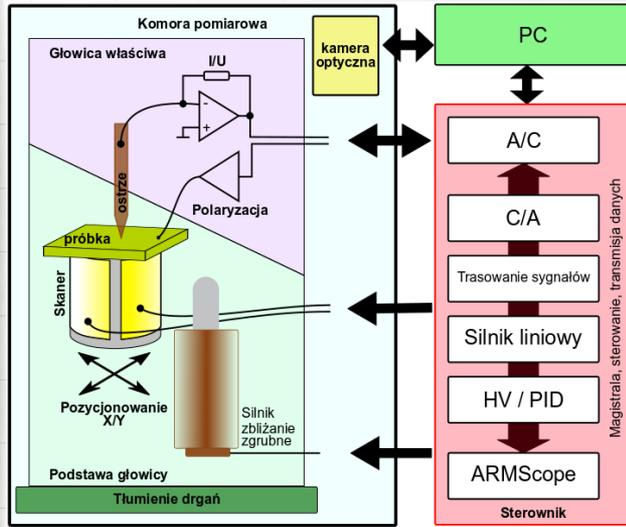
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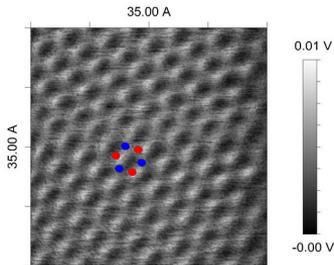
Atomic force microscopy
techniques adaptation for GNEMS

GNEMS investigations

STM capable to investigate GNE

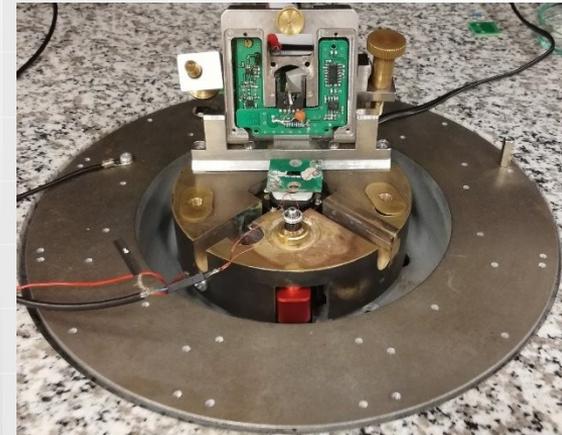


- Movable tip
- Movable sample
- Sample movement in X/Y axis
- Constant current and constant height modes
- STM related modes introduced:
 - STP
 - $z-U_{\text{bias}}$ spectroscopy



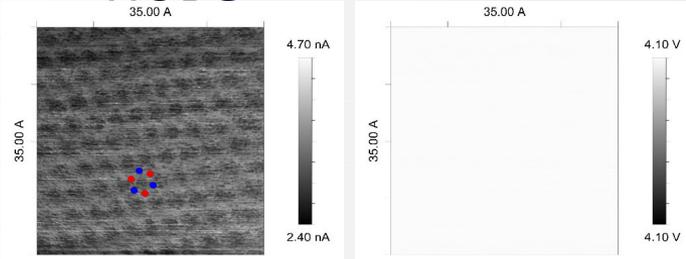
Gajewski, K., et al., Microel. Eng., 212 2019, 1-8

Gajewski, K., et al., MST, 28(3) 2017, 034012

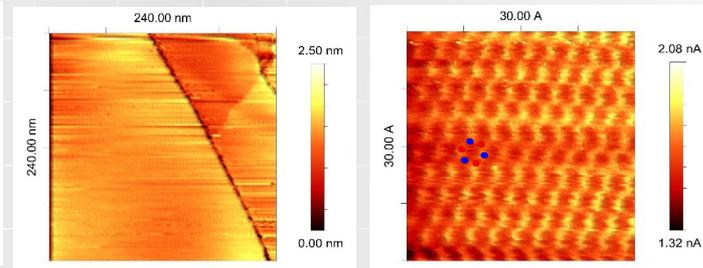


Introduced measurement modes

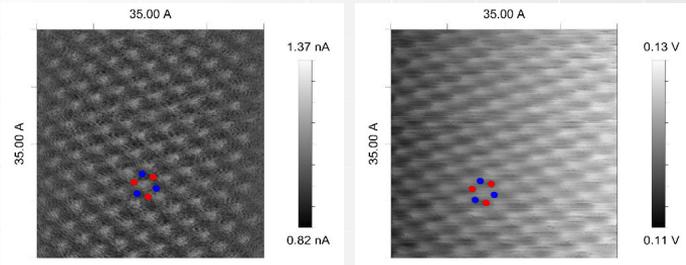
Constant height -



AC-STM - HOPG

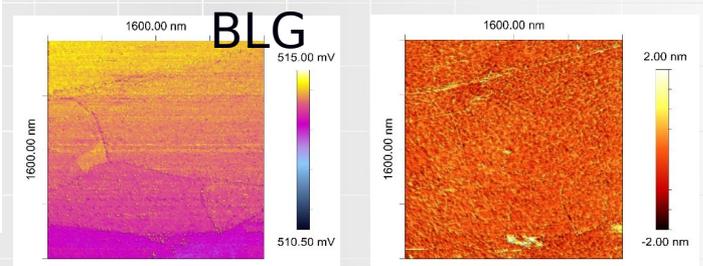


Constant current -



Topography Tunneling current

STP - EPFL



Potential distribution

Topography

Tunneling current

U_{PID}

HOPG in the atomic scale ($35 \text{ \AA} \times 35 \text{ \AA}$), $I_t = 1 \text{ nA}$,

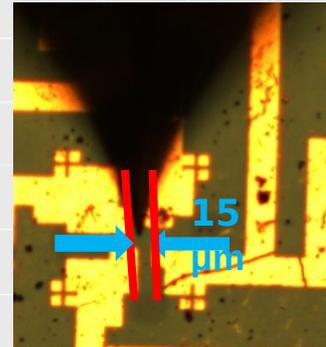
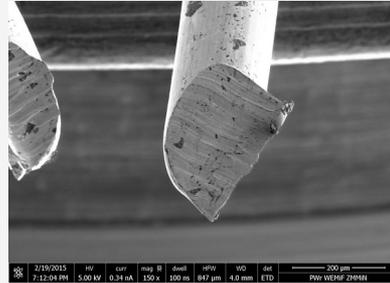
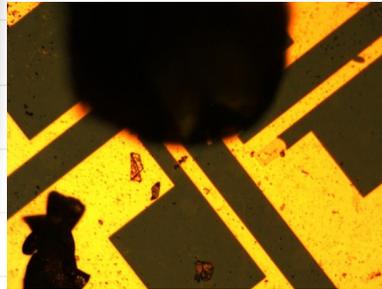
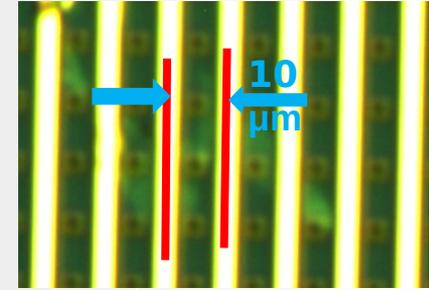
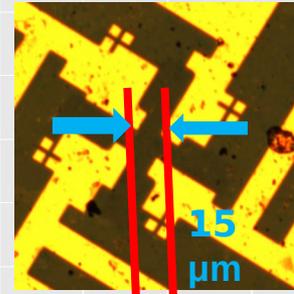
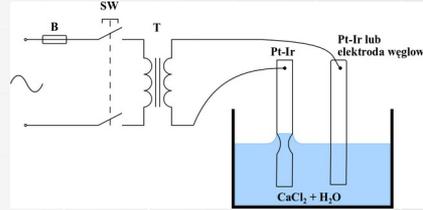
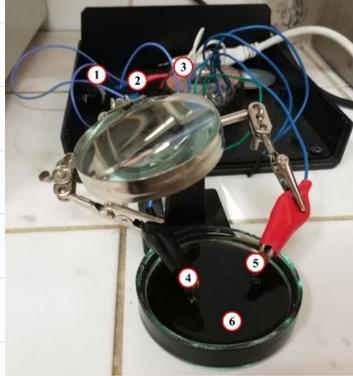
$U_{bias} = 100 \text{ mV}$

STP, $1600 \text{ nm} \times 1600 \text{ nm}$

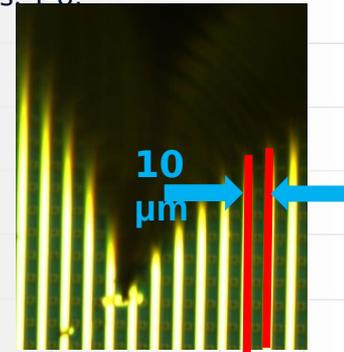
$I_{AC} = 1 \text{ nA}$, $U_{AC} = 30 \text{ mV}$, $f_{AC} = 30 \text{ kHz}$

Optical observation and STM tip etching

Small sample requires capability of its optical observation



Tamulewicz, M., Kutrowska-Girzycka, J., **Gajewski, K.**, et al., Nanotechnology. 24 (30) 2019, s. 1-8.

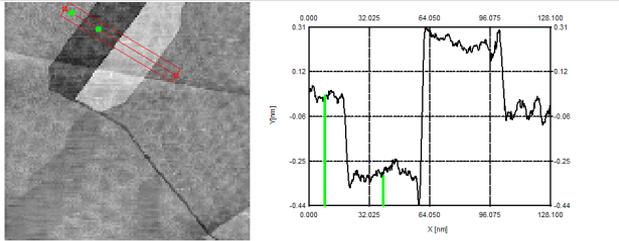


Optical camera,
cutted tip

SEM

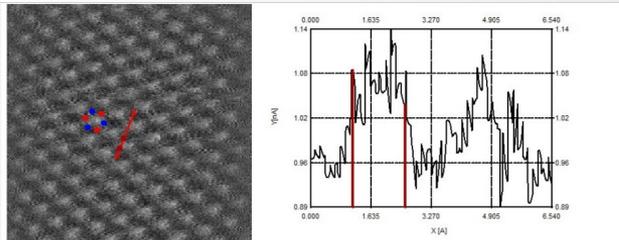
STM Microscope scaling

Z



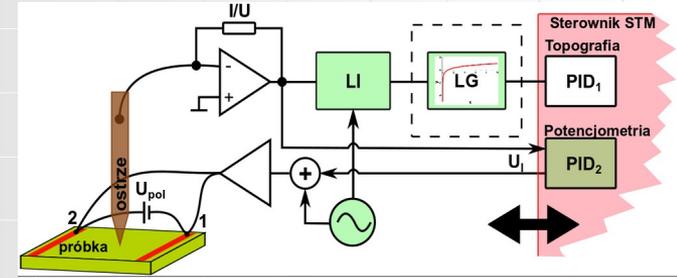
Scanfield [240.0 x 240.0] nm
 Resolution [128 x 128] pixels
 Height: 0.83 nm Position: 8.327 nm Heights difference: 0.00 nm Positions difference: 0.000 nm
 Height: -0.31 nm Position: 39.334 nm Heights difference: -0.34 nm Positions difference: 31.006 nm

6.08 nm/V, Moiré pattern on HOPG
 X/Y

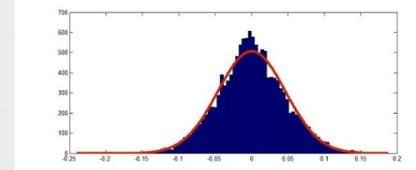
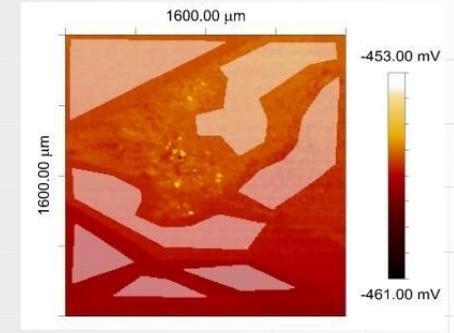
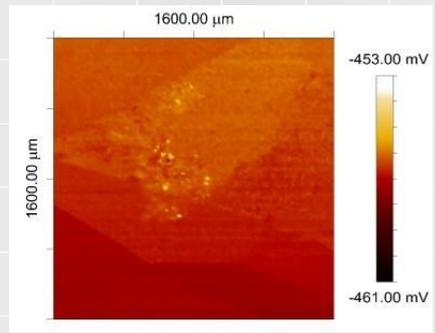


Scanfield [33.0 x 33.0] Å
 Resolution [256 x 256] pixels
 Height: 1.00 nA Position: 1.140 Å Heights difference: 0.00 nA Positions difference: 0.000 Å
 Height: 1.04 nA Position: 2.560 Å Heights difference: -0.05 nA Positions difference: 1.420 Å

Atomic scale 33 Å x 33 Å



Minimal detectable potential, CVD graphene/ Al_2O_3



47 μV

I.e. Keithley 2400, minimal error $\geq 300 \mu\text{V}$!!!

The main goal could be achieved by:

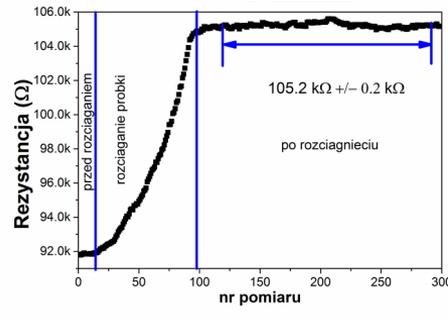
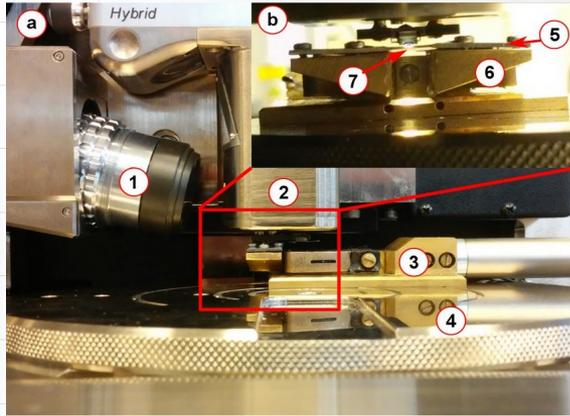
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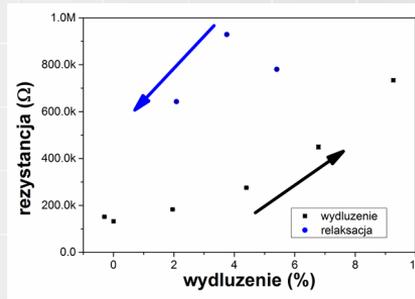
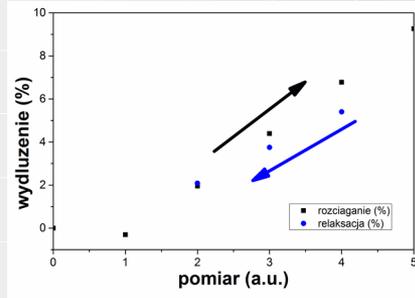
GNEMS investigations

KPFM of the elongated sample – grapgene/LDPE



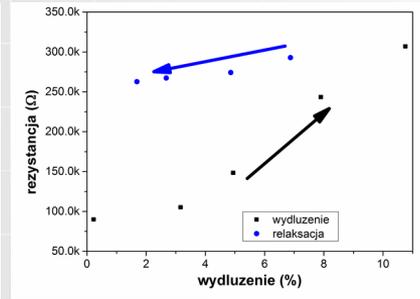
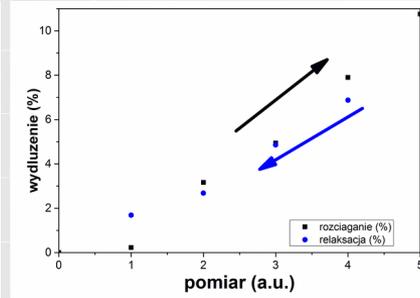
Gajewski, K., et al., Diamond and Related Materials, 82 2018, pp. 143-149

HSMG



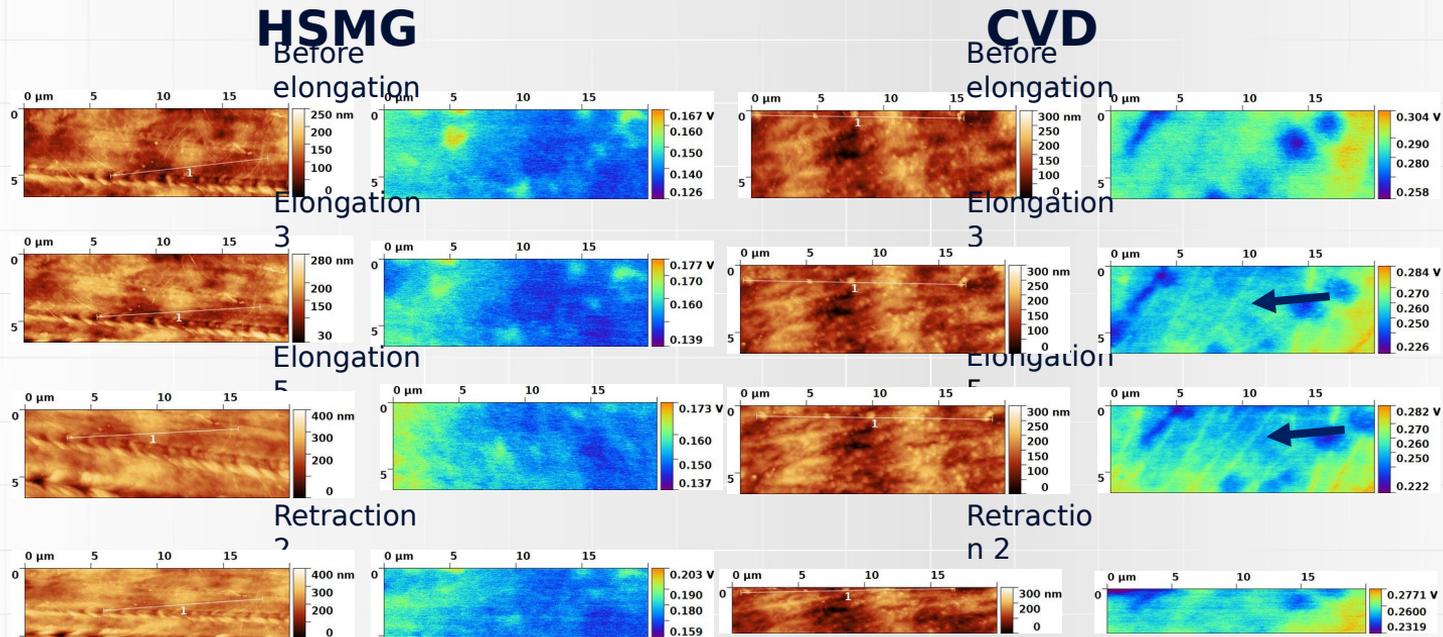
WF ~4.59 - 4.62

CVD



WF ~4.52 - 4.43

KPFM of the elongated sample – grapgene/LDPE



CVD graphene exhibited additional details caused by the sample elongation,
HSMG WF ~4.59 – 4.62 eV, CVD WF ~4.52 – 4.43 eV
GF ~70 (HSMG) / 30 (CVD)

Gajewski, K., et al., Diamond and Related Materials, 82 2018, 143-149

GF from publications 10 – 35
Amjadi et al., Advanced Functional, Materials, vol. 26, no. 11, pp. 1678-1698, 2016

The main goal could be achieved by:

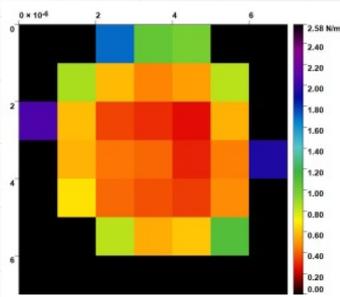
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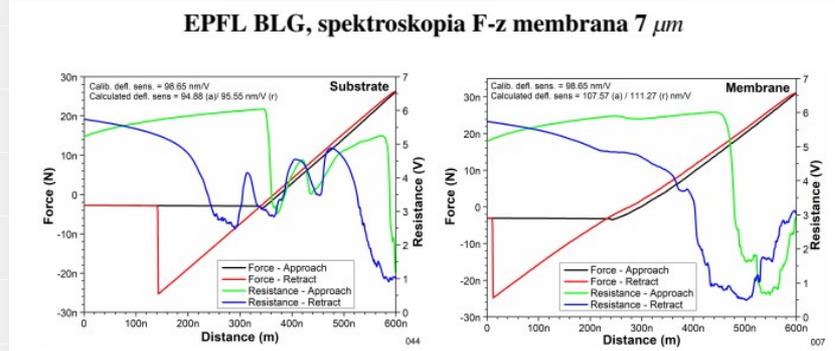
Electromechanical properties investigations using AFM



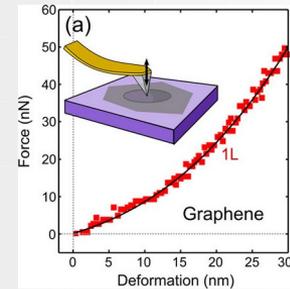
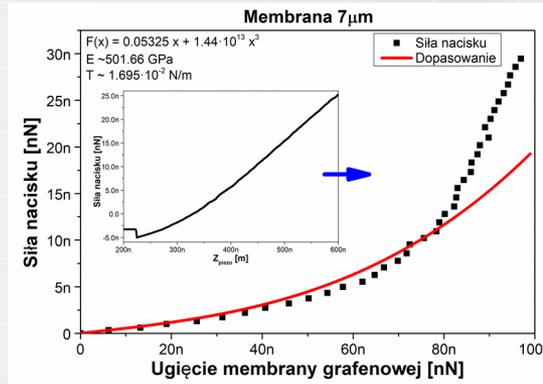
- Stiffness mapping, 7 μm membrane

$$k_{membrana} = \frac{k_{AFM} k_{eff}}{k_{AFM} - k_{eff}}$$

Średnica [μm]	k [N/m]
2	0.309
4	0.186
7	0.218
10	0.230

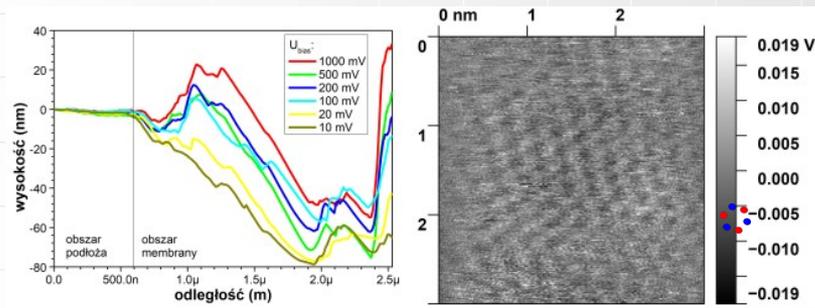
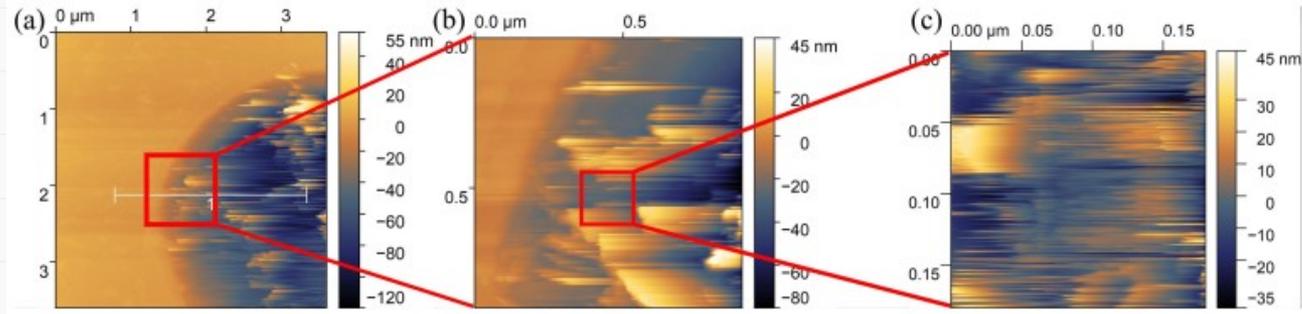


$$F = \left[\frac{4\pi t^3}{3(1-\nu^2)R^2} E + \pi T \right] \delta + \frac{tE}{q^3 R^2} \delta^3$$



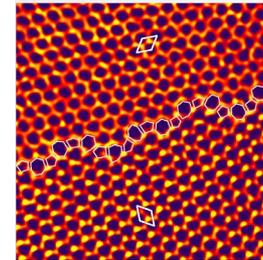
C. Lee et al., Science **321**(5887), 385-388 (2008).

Observation of graphene membrane deformation during STM measurement.



$$\Delta U \sim 1V \rightarrow \Delta z \sim 35 \text{ nm}$$

Alternative for TEM?



TEM

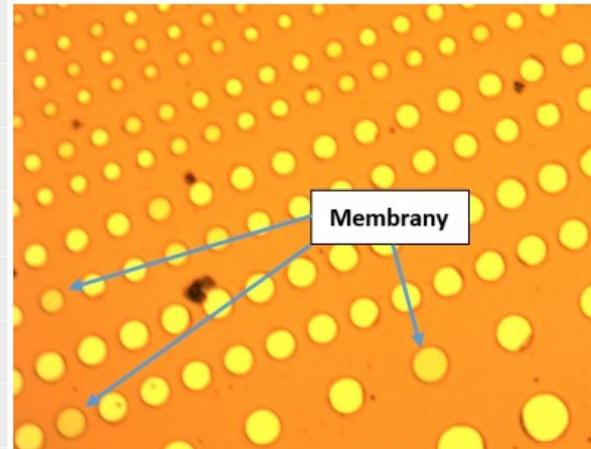
<https://www.jeol.co.jp/en/products/detail/JEM-2100.html>

H. Rasool,
Nature Comm.,
vol. 4, 2013

Observation of the natural resonance of a graphene membrane – laser vibrometry



EPFL
BLG

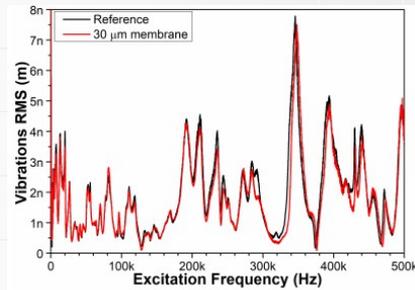


Cooperation with
mgr inż. Piotr
Kunicki

Observation of the natural resonance of a graphene membrane – laser vibrometry

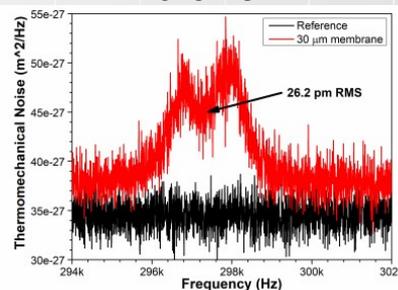
Measurements in vacuum

Enforced vibrations



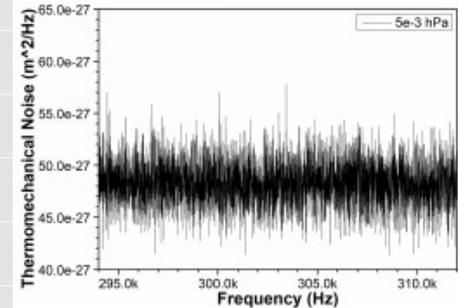
(a)

Natural vibration

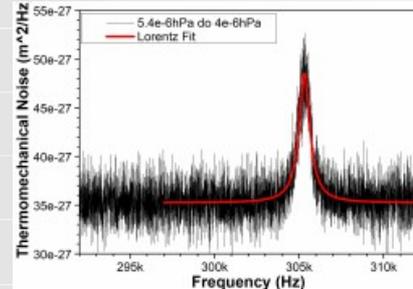


(b)

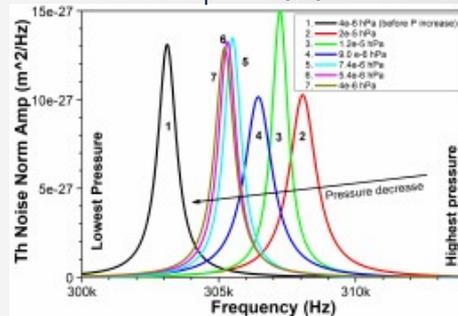
5e-1 Pa



5e-4 Pa



$$f_r = f(P)$$



How far it was / it from Nokia?

STRENGTH-FLAW RELATIONSHIP OF CORRODED PRISTINE SILICA STUDIED BY ATOMIC FORCE MICROSCOPY

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AT&T Bell Laboratories, Murray Hill, NJ 07974

APPLIED PHYSICS LETTERS

VOLUME 77, NUMBER 3

17 JULY 2000

ABSTRACT

Glass strength-flaw relationship is difficult to model as part of the corrosion process. In this paper, we present a spatially-resolved excellent strength-flaw relationship modeled as part of the corrosion process. The results have assumed that

Metal-insulator-semiconductor tunneling microscope: two-dimensional dopant profiling of semiconductors with conducting atomic-force microscopy

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*Bell Laboratories, Lucent Technologies, Murray Hill, New Jersey 07974 and Optoelectronics Center,
Lucent Technologies, Breinigsville, Pennsylvania 18031*

M. Geva
Optoelectronics Center, Lucent Technologies, Breinigsville, Pennsylvania

J. P. Garno and R. N. Kleiman
Bell Laboratories, Lucent Technologies, Murray Hill, New Jersey 07974

(Received 20 March 2000; accepted for publication 24 May 2000)

A method for two-dimensional carrier profiling is presented, based on a conducting atomic-force microscope (AFM) probe tip to a semiconductor surface. Data taken during the AFM scan on a cross-sectioned sample consisting of InP. Modeling of the data shows a clear dependence of the current-voltage characteristics and different behavior for *n*- and *p*-type InP. Modeling of the data is a quantitative tool for high-resolution two-dimensional dopant profiling. *Institute of Physics*. [S0003-6951(00)03329-5]

Scanning capacitance microscopy imaging of silicon metal-oxide-semiconductor field effect transistors*

R. N. Kleiman,^{a)} M. L. O'Malley, F. H. Baumann, J. P. Garno, and G. L. Timp
Bell Laboratories, Lucent Technologies, Murray Hill, New Jersey 07974

(Received 17 January 2000; accepted 31 May 2000)

We have studied cross-sectioned *n*- and *p*-metal-oxide-semiconductor field effect transistors with gate lengths approaching 60 nm using a scanning capacitance microscope (SCM). In a homogeneous semiconductor, the SCM measures the depletion length, determining the dopant concentration. When imaging a real device there is an interaction between the probe tip and the built-in depletion of the *p-n* junction. With the help of a device simulator, we can understand the relation between the SCM images and the position of the *p-n* junction, making the SCM a quantitative tool for junction delineation and direct measurement of the electrical channel length.

© 2000 American Vacuum Society. [S0734-211X(00)08604-2]

Summary

PhD thesis
presented
(just extract)

Wants more?

<https://dbc.wroc.pl/dlibra/publication/141090/edition/72968>

NOKIA